

Project	IEEE 802.21 Media Independent Handover Services < <a href="http://www.ieee802.org/21/">http://www.ieee802.org/21/</a> >	
Title	Liaison to IETF MIPSHOP from 802.21	
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Re:	Support for IETF MIPSHOP Mobility Services Transport Design Team work	
Abstract	This document is a letter to IETF MIPSHOP, expressing the support of IEEE 802.21 for the MIPSHOP Mobility Services Transport Design Team effort on designing MIH transport.	
Purpose	To send a letter to IETF MIPSHOP from IEEE 802.21	
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From: Vivek Gupta (vivek.g.gupta@intel.com), Chair, IEEE 802.21 Working Group  
Michael G. Williams (michael.g.williams@nokia.com), Vice Chair, IEEE 802.21

To: Stefano Faccin (smfaccin@marvell.com), Co-chair, IETF MIPSHOP  
Vijay Devarapalli (vijay.devarapalli@azairenet.com), Co-chair, IETF MIPSHOP

Title: Support for IETF MIPSHOP Mobility Services Transport Design Team work

Dear Stefano, Vijay,

On behalf of the IEEE 802.21 Working Group, we would like to inform you that the IEEE 802 LMSC has given approval to IEEE 802.21/Draft D7.0 specification to Sponsor Ballot. Therefore, the IEEE 802.21 WG strongly encourages the MIPSHOP Mobility Services Transport Design Team to expedite the development of a transport for the MIH protocol.

We look forward to additional discussions with IETF MIPSHOP WG and invite you to attend our future meetings scheduled for September 16<sup>th</sup> – 21<sup>st</sup> 2007, Big Island, Hawaii, and on Nov-11-16 in Atlanta, USA.

Please feel free to contact us in case you have any further questions in this regard.

Best Regards,  
Vivek Gupta  
Michael G. Williams

cc: Yoshihiro Ohba, IEE 802.21 liaison to IETF